

### PIC16F193X/LF193X/ PIC16F194X/LF194X/ PIC16LF190X

### PIC16F193X/LF193X/PIC16F194X/LF194X/PIC16LF190X Memory Programming Specification

# This document includes the programming specifications for the following devices:

- PIC16F1933 PIC16F1934 PIC16F1936
- PIC16F1937 PIC16F1938 PIC16F1939
- PIC16F1946 PIC16F1947 PIC16LF1902
- PIC16LF1903 PIC16LF1904 PIC16LF1906
- PIC16LF1907 PIC16LF1933 PIC16LF1934
- PIC16LF1936 PIC16LF1937 PIC16LF1938
- PIC16LF1939 PIC16LF1946 PIC16LF1947

### 1.0 OVERVIEW

The device can be programmed using either the highvoltage In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>) method or the low-voltage ICSP method.

#### 1.1 Hardware Requirements

1.1.1 HIGH-VOLTAGE ICSP PROGRAMMING

In High-Voltage ICSP mode, the device requires two programmable power supplies: one for VDD and one for the MCLR/VPP pin.

#### 1.1.2 LOW-VOLTAGE ICSP PROGRAMMING

In Low-Voltage ICSP mode, the PIC16F193X/194X and PIC16LF193X/194X/190X devices can be programmed using <u>a single VDD</u> source in the operating range. The MCLR/VPP pin does not have to be brought to a different voltage, but can instead be left at the normal operating voltage.

#### 1.1.2.1 Single-Supply ICSP Programming

The LVP bit in Configuration Word 2 enables singlesupply (low-voltage) ICSP programming. The LVP bit defaults to a '1' (enabled) from the factory. The LVP bit may only be programmed to '0' by entering the High-Voltage ICSP mode, where MCLR/VPP pin is raised to VIHH. Once the LVP bit is programmed to a '0', only the High-Voltage ICSP mode is available and only the High-Voltage ICSP mode can be used to program the device.

- Note 1: The High-Voltage ICSP mode is always available, regardless of the state of the LVP bit, by applying VIHH to the MCLR/ VPP pin.
  - 2: While in Low-Voltage ICSP mode, MCLR is always enabled, regardless of the MCLRE bit, and the port pin can no longer be used as a general purpose input.

#### 1.2 Pin Utilization

Five pins are needed for ICSP programming. The pins are listed in Table 1-1 and Table 1-2.

#### TABLE 1-1:PIN DESCRIPTIONS DURING PROGRAMMING FOR PIC16F193X/LF193X/LF190X

Pin Name	During Programming				
	Function	Pin Type	Pin Description		
RB6	ICSPCLK I Clock Input – Schmitt Trigger		Clock Input – Schmitt Trigger Input		
RB7	ICSPDAT	I/O	Data Input/Output – Schmitt Trigger Input		
RE3/MCLR/VPP	MCLR/VPP Program/Verify mode P <sup>(1)</sup>		Program Mode Select/Programming Power Supply		
Vdd	Vdd	Р	Power Supply		
Vss	Vss	Р	Ground		

**Legend:** I = Input, O = Output, P = Power

**Note 1:** The programming high <u>voltage</u> is internally generated. To activate the Program/Verify mode, high voltage needs to be applied to MCLR input. Since the MCLR is used for a level source, MCLR does not draw any significant current.

TABLE 1-2:	ABLE 1-2: PIN DESCRIPTIONS DURING PROGRAMMING FOR PICTOF 194A/LF 194A					
Pin Name	During Programming					
	Function	Pin Type	Pin Description			
RB6	ICSPCLK	Ι	Clock Input – Schmitt Trigger Input			
RB7	ICSPDAT	I/O	Data Input/Output – Schmitt Trigger Input			
RG5/MCLR/VPP	Program/Verify mode	P <sup>(1)</sup>	Program Mode Select/Programming Power Supply			
Vdd	Vdd	Р	Power Supply			
Vss	Vss	Р	Ground			

### TABLE 1-2: PIN DESCRIPTIONS DURING PROGRAMMING FOR PIC16F194X/LF194X

Legend: I = Input, O = Output, P = Power

**Note 1:** The programming high <u>voltage</u> is internally generated. To activate the Program/Verify mode, high voltage needs to be applied to MCLR input. Since the MCLR is used for a level source, MCLR does not draw any significant current.

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### 2.0 DEVICE PINOUTS

The pin diagrams for the PIC16F193X/LF193X/ PIC16F194X/LF194X/PIC16LF190X family are shown in Figure 2-1 through Figure 2-6. The pins that are required for programming are listed in Table 1-1 and shown in bold lettering in the pin diagrams.

#### FIGURE 2-1: 28-PIN PDIP/SOIC/SSOP DIAGRAM FOR PIC16F1933/1936/1938, PIC16LF1933/ 1936/1938 AND PIC16LF1902/1903/1906



#### FIGURE 2-2: 28-PIN QFN/UQFN PACKAGE DIAGRAM FOR PIC16F1933/1936/1938, PIC16LF1933/1936/1938 AND PIC16LF1902/1903/1906



#### FIGURE 2-3: 40-PIN PDIP PACKAGE DIAGRAM FOR PIC16F1934/1937/1939, PIC16LF1934/ 1937/1939 AND PIC16LF1904/1907



### FIGURE 2-4: 44-PIN QFN PACKAGE DIAGRAM FOR PIC16F1934/1937/1939 AND PIC16LF1934/1937/1939



#### FIGURE 2-5: 44-PIN TQFP PACKAGE DIAGRAM FOR PIC16F1934/1937/1939, PIC16LF1934/ 1937/1939 AND PIC16LF1904/1907









### 3.0 MEMORY MAP

The memory is broken into two sections: program memory and configuration memory. Only the size of the program memory changes between devices, the configuration memory remains the same.





#### FIGURE 3-2: PIC16F1933/PIC16LF1933, PIC16F1934/PIC16LF1934, PIC16LF1903/ PIC16LF1904 PROGRAM MEMORY MAPPING



#### FIGURE 3-3: PIC16F1936/PIC16LF1936, PIC16F1937/PIC16LF1937, PIC16F1946/PIC16LF1946/ PIC16LF1906/PIC16LF1907 PROGRAM MEMORY MAPPING



#### FIGURE 3-4: PIC16F1938/PIC16LF1938, PIC16F1939/PIC16LF1939, PIC16F1947/PIC16LF1947 PROGRAM MEMORY MAPPING



#### 3.1 User ID Location

A user may store identification information (user ID) in four designated locations. The user ID locations are mapped to 8000h-8003h. Each location is 14 bits in length. Code protection has no effect on these memory locations. Each location may be read with code protection enabled or disabled.

Note:	MPLAB <sup>®</sup> IDE only displays the 7 Least
	Significant bits (LSb) of each user ID
	location, the upper bits are not read. It is
	recommended that only the 7 LSb's be
	used if MPLAB IDE is the primary tool
	used to read these addresses.

#### 3.2 Device ID

The device ID word is located at 8006h. This location is read-only and cannot be erased or modified.

#### **REGISTER 3-1: DEVICEID: DEVICE ID REGISTER**<sup>(1)</sup>

R-q	R-q	R-q	R-q	R-q	R-q	R-q
DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	DEV2
bit 13						bit 7

R-q	R-q	R-q	R-q	R-q	R-q	R-q
DEV1	DEV0	REV4	REV3	REV2	REV1	REV0
bit 6						bit 0

Legend:	P = Programmable bit	U = Unimplemented bit, read as '0'
R = Readable bit	W = Writable bit	'0' = Bit is cleared
-n = Value at POR	'1' = Bit is set	x = Bit is unknown

bit 13-5 **DEV<8:0>:** Device ID bits

These bits are used to identify the part number.

bit 4-0 **REV<4:0>:** Revision ID bits

These bits are used to identify the revision.

Note 1: This location cannot be written.

DEVICE	DEVICE	DEVICE ID VALUES				
DEVICE	DEV	REV				
PIC16F1933	10 0011 000	x xxxx				
PIC16F1934	10 0011 010	x xxxx				
PIC16F1936	10 0011 011	x xxxx				
PIC16F1937	10 0011 100	x xxxx				
PIC16F1938	10 0011 101	x xxxx				
PIC16F1939	10 0011 110	x xxxx				
PIC16F1946	10 0101 000	x xxxx				
PIC16F1947	10 0101 001	x xxxx				
PIC16LF1933	10 0100 000	x xxxx				
PIC16LF1934	10 0100 010	x xxxx				
PIC16LF1936	10 0100 011	x xxxx				
PIC16LF1937	10 0100 100	x xxxx				
PIC16LF1938	10 0100 101	x xxxx				
PIC16LF1939	10 0100 110	x xxxx				
PIC16LF1946	10 0101 100	x xxxx				
PIC16LF1947	10 0101 101	x xxxx				
PIC16LF1902	10 1100 001	x xxxx				
PIC16LF1903	10 1100 000	X XXXX				
PIC16LF1904	10 1100 100	x xxxx				
PIC16LF1906	10 1100 011	x xxxx				
PIC16LF1907	10 1100 010	x xxxx				

### 3.3 Configuration Words

The device has two Configuration Words, Configuration Word 1 (8007h) and Configuration Word 2 (8008h). The individual bits within these Configuration Words are used to enable or disable device functions such as the Brown-out Reset, code protection and Power-up Timer.

#### 3.4 Calibration Words

The internal calibration values are factory calibrated and stored in Calibration Words 1 and 2 (8009h and 800Ah).

The Calibration Words do not participate in erase operations. The device can be erased without affecting the Calibration Words.

R/P-1 <sup>(4)</sup>	R/P-1 <sup>(4)</sup>	R/P-1	R/P-1	R/P-1	R/P-1 <sup>(4)</sup>	R/P-1
FCMEN	IESO	CLKOUTEN	BOREN1	BOREN0	CPD	CP
bit 13						bit
R/P-1	R/P-1	R/P-1	R/P-1	R/P-1 <sup>(4)</sup>	R/P-1	R/P-1
MCLRE	PWRTE	WDTE1	WDTE0	FOSC2	FOSC1	FOSC0
bit 6	TWICE	WDIEI	WDTE	10002	10001	bit
Legend:				U = Unimplemer	nted bit, read as '	0'
R = Readable	bit	W = Writable bit		'0' = Bit is cleare	ed	
-n = Value at P	POR	'1' = Bit is set		x = Bit is unknow	vn	
bit 13 <sup>(4)</sup>	1 = Fail-Safe C	afe Clock Monitor lock Monitor is en lock Monitor is dis	abled			
bit 12 <sup>(4)</sup>	1 = Internal/Ext	External Switchov ernal Switchover i ernal Switchover i	mode is enabled			
bit 11	CLKOUTEN: C 1 = CLKOUT f	Clock Out Enable b unction is disabled unction is enabled	it I. I/O or oscillato	r function on RA6	/CLKOUT	
bit 10-9	11 = BOR enat 10 = BOR enat	oled during operation	ion and disabled			
bit 8 <sup>(4)</sup>	<b>CPD</b> : Data Coo 1 = Data memo	le Protection bit <sup>(2)</sup> bry code protection bry code protection				
bit 7	<b>CP</b> : Code Prote	•	ction is disabled			
bit 6	$\frac{\text{If LVP bit = 1}}{\text{This bit is ig}}$ $\frac{\text{If LVP bit = 0}}{1 = \text{MCLR}}$ $0 = \text{MCLR}$	Image: WPP Pin Function           gnored.           /PP pin function is           /PP pin function is           s WPU control bit.	MCLR; Weak pul		led; Weak pull-up	o under control
bit 5		r-up Timer Enable abled	bit <sup>(1)</sup>			
2: The	entire data EEPF	Reset does not aut ROM will be erase nemory will be eras	d when the code	protection is turn	ed off during an	erase.

#### REGISTER 3-2: **CONFIGURATION WORD 1**

- 4: Unemplemented on PIC16LF190X devices. This bit reads as '1'.
- 5: For PIC16LF190X only.

### REGISTER 3-2: CONFIGURATION WORD 1 (CONTINUED)

bit 4-3	WDTE<1:0>: Watchdog Timer Enable bit 11 = WDT enabled 10 = WDT enabled while running and disabled in Sleep 01 = WDT controlled by the SWDTEN bit in the WDTCON register 00 = WDT disabled
bit 2-0	<ul> <li>FOSC&lt;2:0&gt;: Oscillator Selection bits</li> <li>111 = ECH: External Clock, High-Power mode: CLKIN on RA7/OSC1/CLKIN</li> <li>100 = ECM: External Clock, Medium-Power mode: CLKIN on RA7/OSC1/CLKIN</li> <li>101 = ECL: External Clock, Low-Power mode: CLKIN on RA7/OSC1/CLKIN</li> <li>100 = INTOSC oscillator: I/O function on RA7/OSC1/CLKIN</li> <li>011 = EXTRC oscillator: RC function on RA7/OSC1/CLKIN</li> <li>010 = HS oscillator: High-speed crystal/resonator on RA6/OSC2/CLKOUT pin and RA7/OSC1/ CLKIN</li> <li>001 = XT oscillator: Crystal/resonator on RA6/OSC2/CLKOUT pin and RA7/OSC1/ CLKIN</li> <li>001 = LP oscillator: Low-power crystal on RA6/OSC2/CLKOUT pin and RA7/OSC1/CLKIN</li> </ul>
bit 2 <sup>(5)</sup>	Unemplemented: Read as '1'
bit 1-0 <sup>(5)</sup>	FOSC<1:0>: Oscillator Selection bits
	<ul> <li>INTOSC Oscillator: I/O function on RA7/CLKIN</li> <li>ECL: External Clock, Low-Power mode: CLKIN on RA7/OSC1/CLKIN</li> <li>ECM: External Clock, Medium-Power mode: CLKIN on RA7/OSC1/CLKIN</li> <li>ECH: External Clock, High-Power mode: CLKIN on RA7/CLKIN</li> </ul>
Note 1:	Enabling Brown-out Reset does not automatically enable Power-up Timer.

- **2:** The entire data EEPROM will be erased when the code protection is turned off during an erase.
- 3: The entire program memory will be erased when the code protection is turned off.
- 4: Unemplemented on PIC16LF190X devices. This bit reads as '1'.
- 5: For PIC16LF190X only.

R/P-1	R/P-1	R/P-1 <sup>(5)</sup>	R/P-1	R/P-1	R/P-1	U-1
LVP	DEBUG		BORV	STVREN	PLLEN	
bit 13						bit
U-1	R/P-1	R/P-1	U-1	U-1	R/P-1	R/P-1
—	VCAPEN1 <sup>(1)</sup>	VCAPEN0 <sup>(1)</sup> VCAPEN <sup>(2)</sup>	_	—	WRT1	WRT0
bit 6						bit
Legend:				U = Unimplemer	ited bit, read as '	0'
R = Readable bit		W = Writable bit		'0' = Bit is cleare	d	
-n = Value at POI	२	'1' = Bit is set		x = Bit is unknow	/n	
bit 12	1 = Low-voltage 0 = MCLR/VPP DEBUG: In-Circ 1 = In-Circuit De		ibled irogramming hi e bit RB6/ICSPCLK	gh voltage and RB7/ICSPDA and RB7/ICSPDA		
	Unimplemente					
bit 11 <sup>(5)</sup>	ULPBOR: Ultra	Low-Power BOR ower BOR is disabl	ed			
	1 = Brown-out F	out Reset Voltage S Reset voltage set to Reset voltage set to	o 1.9V			
	1 = Stack overfl	COverflow/Underflow ow or underflow w ow or underflow w	ill cause a Res	et		
	PLLEN: PLL Er 1 = 4xPLL enab 0 = 4xPLL disat	oled				
bit 7-6	Unimplemente	d: Read as '1'				
,	<b>VCAPEN&lt;1:0&gt;</b> PIC16LF193x:	1933/1934/1936/19 <sup>(1)</sup> : Voltage Regula	tor Capacitor E		bled	
I	PIC16F193x: 00 =VCAP f 01 =VCAP f 10 =VCAP f	unctionality is enal unctionality is enal unctionality is enal P pin functions are	bled on RA0 bled on RA5 bled on RA6			
bit 5	Unimplemente	d: Read as '1'				
2: For PI 3: The LV				mming mode is en	tered via LVP.	

#### **REGISTER 3-3: CONFIGURATION WORD 2 (CONTINUED)** bit 4<sup>(2, 4)</sup> For the PIC16F1946/1947: VCAPEN<sup>(2)</sup>: Voltage Regulator Capacitor Enable bits PIC16LF194x: This bit is unimplemented. All VCAP pin functions are disabled. PIC16F194x: 0 = VCAP functionality is enabled on RF0 1 = All VCAP pin functions are disabled bit 3-2 Unimplemented: Read as '1' bit 1-0 WRT<1:0>: Flash Memory Self-write Protection bits 4 kW Flash memory (PIC16F1933/PIC16LF1933 and PIC16F1934/PIC16LF1934 only): 11 = Write protection off 10 = 000h to 1FFh write protected. 200h to FFFh may be modified by EECON control 01 = 000h to 7FFh write protected. 800h to FFFh may be modified by EECON control 00 = 000h to FFFh write protected, no addresses may be modified by EECON control 8 kW Flash memory (PIC16F1936/PIC16LF1936, PIC16F1937/PIC16LF1937 and PIC16F1946/ PIC16LF1946): 11 = Write protection off 10 = 000h to 1FFh write protected. 200h to 1FFFh may be modified by EECON control 01 = 000h to FFFh write protected, 1000h to 1FFFh may be modified by EECON control 00 = 000h to 1FFFh write protected, no addresses may be modified by EECON control 16 kW Flash memory (PIC16F1938/PIC16LF1938, PIC16F1939/PIC16LF1939 and PIC16F1947/ PIC16LF1947): 11 = Write protection off 10 = 000h to 1FFh write protected. 200h to 3FFFh may be modified by EECON control 01 = 000h to 1FFFh write protected. 2000h to 3FFFh may be modified by EECON control 00 = 000h to 3FFFh write protected, no addresses may be modified by EECON control bit 1-0<sup>(5)</sup> WRT<1:0>: Flash Memory Self-Write Protection bits 2 kW Flash memory: PIC16LF1902: 11 = Write protection off 10 = 000h to 1FFh write protected, 200h to 7FFh may be modified by PMCON control 01 = 000h to 3FFh write protected, 400h to 7FFh may be modified by PMCON control 00 = 000h to 7FFh write protected, no addresses may be modified by PMCON control 4 kW Flash memory: PIC16LF1903/1904: 11 = Write protection off 10 = 000h to 1FFh write protected, 200h to FFFh may be modified by PMCON control 01 = 000h to 7FFh write protected, 800h to FFFh may be modified by PMCON control 00 = 000h to FFFh write protected, no addresses may be modified by PMCON control 8 kW Flash memory: PIC16LF1906/1907: 11 = Write protection off 10 = 000h to 1FFh write protected, 200h to 1FFFh may be modified by PMCON control 01 = 000h to FFFh write protected, 1000h to 1FFFh may be modified by PMCON control 00 = 000h to 1FFFh write protected, no addresses may be modified by PMCON control

#### Note 1: For PIC16F193X only.

- 2: For PIC16F194X only.
- 3: The LVP bit cannot be programmed to '0' when Programming mode is entered via LVP.
- 4: Unemplemented on PIC16LF190X devices. This bit reads as '1'.
- 5: For PIC16LF190X only.

### 4.0 PROGRAM/VERIFY MODE

In Program/Verify mode, the program memory and the configuration memory can be accessed and programmed in serial fashion. ICSPDAT and ICSPCLK are used for the data and the clock, respectively. All commands and data words are transmitted LSb first. Data changes on the rising edge of the ICSPCLK and latched on the falling edge. In Program/Verify mode both the ICSPDAT and ICSPCLK are Schmitt Trigger inputs. The sequence that enters the device into Program/Verify mode places all other logic into the Reset state. Upon entering Program/Verify mode, all I/O's are automatically configured as high-impedance inputs and the address is cleared.

#### 4.1 High-Voltage Program/Verify Mode Entry and Exit

There are two different methods of entering Program/ Verify mode via high-voltage:

- VPP First entry mode
- VDD First entry mode

#### 4.1.1 VPP – FIRST ENTRY MODE

To enter Program/Verify mode via the VPP-first method the following sequence must be followed:

- 1. Hold ICSPCLK and ICSPDAT low. All other pins should be unpowered.
- 2. Raise the voltage on MCLR from 0V to VIHH.
- 3. Raise the voltage on VDD from 0V to the desired operating voltage.

The VPP-first entry prevents the device from executing code prior to entering Program/Verify mode. For example, when the Configuration Word has  $\overline{\text{MCLR}}$  disabled (MCLRE = 0), the power-up time is disabled ( $\overline{\text{PWRTE}}$  = 0), the internal oscillator is selected ( $\overline{\text{Fosc}}$  = 100), and RB6 and RB7 are driven by the user application, the device will execute code. Since this may prevent entry, VPP-first entry mode is strongly recommended. See the timing diagram in Figure 8-3.

#### 4.1.2 VDD – FIRST ENTRY MODE

To enter Program/Verify mode via the VDD-first method the following sequence must be followed:

- 1. Hold ICSPCLK and ICSPDAT low.
- 2. Raise the voltage on VDD from 0V to the desired operating voltage.
- 3. Raise the voltage on MCLR from VDD or below to VIHH.

The VDD-first method is useful when programming the device when VDD is already applied, for it is not necessary to disconnect VDD to enter Program/Verify mode. See the timing diagram in Figure 8-2.

#### 4.1.3 PROGRAM/VERIFY MODE EXIT

To exit Program/Verify mode take MCLR to VDD or lower (VIL). See Figures 8-4 and 8-5.

#### 4.2 Low-Voltage Programming (LVP) Mode

The Low-Voltage Programming mode allows the PIC16F193X/LF193X/PIC16F194X/LF194X/

PIC16LF190X devices to be programmed using VDD only, without high voltage. When the LVP bit of the Configuration Word 2 register is set to '1', the lowvoltage ICSP programming entry is enabled. To disable the Low-Voltage ICSP mode, the LVP bit must be programmed to '0'. This can only be done while in the High-Voltage Entry mode.

Entry into the Low-Voltage ICSP Program/Verify modes requires the following steps:

- 1. MCLR is brought to VIL.
- 2. A 32-bit key sequence is presented on ICSPDAT, while clocking ICSPCLK.

The key sequence is a specific 32-bit pattern, '0100 1101 0100 0011 0100 1000 0101 0000' (more easily remembered as MCHP in ASCII). The device will enter Program/Verify mode only if the sequence is valid. The Least Significant bit of the Least Significant nibble must be shifted in first.

Once the key sequence is complete,  $\overline{\text{MCLR}}$  must be held at VIL for as long as Program/Verify mode is to be maintained.

For low-voltage programming timing, see Figures 8-9 and 8-10.

Exiting <u>Program/Verify</u> mode is done by no longer driving MCLR to VIL. See Figures 8-9 and 8-10.

**Note:** To enter LVP mode, the LSB of the Least Significant nibble must be shifted in first. This differs from entering the key sequence on other parts.

#### 4.3 Program/Verify Commands

The PIC16F193X/194X and PIC16LF193X/194X/190X implement 13 programming commands, each six bits in length. The commands are summarized in Table 4-1.

Commands that have data associated with them are specified to have a minimum delay of TDLY between the command and the data. After this delay 16 clocks are required to either clock in or clock out the 14-bit data word. The first clock is for the Start bit and the last clock is for the Stop bit.

#### TABLE 4-1: COMMAND MAPPING FOR PIC16F193X/LF193X/PIC16F194X/LF194X/PIC16LF190X

Command		Mapping						Data/Note
Commanu	Binary (MSb LSb) Hex							
Load Configuration	Х	0	0	0	0	0	00h	0, data (14), 0
Load Data For Program Memory	Х	0	0	0	1	0	02h	0, data (14), 0
Load Data For Data Memory	Х	0	0	0	1	1	03h	0, data (8), zero (6), 0
Read Data From Program Memory	х	0	0	1	0	0	04h	0, data (14), 0
Read Data From Data Memory	Х	0	0	1	0	1	05h	0, data (8), zero (6), 0
Increment Address	Х	0	0	1	1	0	06h	—
Reset Address	х	1	0	1	1	0	16h	—
Begin Internally Timed Programming	х	0	1	0	0	0	08h	—
Begin Externally Timed Programming	Х	1	1	0	0	0	18h	—
End Externally Timed Programming	х	0	1	0	1	0	0Ah	—
Bulk Erase Program Memory	х	0	1	0	0	1	09h	Internally Timed
Bulk Erase Data Memory	Х	0	1	0	1	1	0Bh	Internally Timed
Row Erase Program Memory	Х	1	0	0	0	1	11h	Internally Timed

#### 4.3.1 LOAD CONFIGURATION

The Load Configuration command is used to access the configuration memory (User ID Locations, Configuration Words, Calibration Words). The Load Configuration command sets the address to 8000h and loads the data latches with one word of data (see Figure 4-1).

After issuing the Load Configuration command, use the Increment Address command until the proper address to be programmed is reached. The address is then programmed by issuing either the Begin Internally Timed Programming or Begin Externally Timed Programming command. **Note:** Externally timed writes are not supported for Configuration and Calibration bits. Any externally timed write to the Configuration or Calibration Word will have no effect on the targeted word.

The only way to get back to the program memory (address 0) is to exit Program/Verify mode or issue the Reset Address command after the configuration memory has been accessed by the Load Configuration command.



#### 4.3.2 LOAD DATA FOR PROGRAM MEMORY

The Load Data for Program Memory command is used to load one 14-bit word into the data latches. The word programs into program memory after the Begin Internally Timed Programming or Begin Externally Timed Programming command is issued (see Figure 4-2).

#### FIGURE 4-2: LOAD DATA FOR PROGRAM MEMORY



#### 4.3.3 LOAD DATA FOR DATA MEMORY

The Load Data for Data Memory command will load a 14-bit "data word" when 16 cycles are applied. However, the data memory is only 8 bits wide and thus, only the first 8 bits of data after the Start bit will be programmed into the data memory. It is still necessary to cycle the clock the full 16 cycles in order to allow the internal circuitry to reset properly (see Figure 4-3).





### 4.3.4 READ DATA FROM PROGRAM MEMORY

The Read Data from Program Memory command will transmit data bits out of the program memory map currently accessed, starting with the second rising edge of the clock input. The ICSPDAT pin will go into Output mode on the first falling clock edge, and it will revert to Input mode (high-impedance) after the 16th falling edge of the clock. If the program memory is code-protected  $(\overline{CP})$ , the data will be read as zeros (see Figure 4-4).

#### FIGURE 4-4: READ DATA FROM PROGRAM MEMORY



#### 4.3.5 READ DATA FROM DATA MEMORY

The Read Data from Data Memory command will transmit data bits out of the data memory starting with the second rising edge of the clock input. The ICSPDAT pin will go into Output mode on the second rising edge, and it will revert to Input mode (high-impedance) after the 16th rising edge. The data memory is 8 bits wide, and therefore, only the first 8 bits that are output are actual data. If the data memory is code-protected, the data is read as all zeros. A timing diagram of this command is shown in Figure 4-5.

#### FIGURE 4-5: READ DATA FROM DATA MEMORY COMMAND



#### 4.3.6 INCREMENT ADDRESS

The address is incremented when this command is received. It is not possible to decrement the address. To reset this counter, the user must use the Reset Address command or exit Program/Verify mode and reenter it.

If the address is incremented from address 7FFFh, it will wrap around to location 0000h. If the address is incremented from FFFFh, it will wrap around to location 8000h.



#### FIGURE 4-6: INCREMENT ADDRESS

#### 4.3.7 RESET ADDRESS

The Reset Address command will reset the address to 0000h, regardless of the current value. The address is used in program memory or the configuration memory.



### 4.3.8 BEGIN INTERNALLY TIMED PROGRAMMING

A Load Configuration or Load Data for Program Memory command must be given before every Begin Programming command. Programming of the addressed memory will begin after this command is received. An internal timing mechanism executes the write. The user must allow for the program cycle time, TPINT, for the programming to complete.

The End Externally Timed Programming command is not needed when the Begin Internally Timed Programming is used to start the programming.

The program memory address that is being programmed is not erased prior to being programmed. However, the EEPROM memory address that is being programmed is erased prior to being programmed with internally timed programming.

#### FIGURE 4-8: BEGIN INTERNALLY TIMED PROGRAMMING



#### 4.3.9 BEGIN EXTERNALLY TIMED PROGRAMMING

A Load Configuration, Load Data for Program Memory or Load Data for Data Memory command must be given before every Begin Programming command. Programming of the addressed memory will begin after this command is received. To complete the programming, the End Externally Timed Programming command must be sent in the specified time window defined by TPEXT. No internal erase is performed for the data EEPROM, therefore, the device should be erased prior to executing this command (see Figure 4-9). Externally timed writes are not supported for Configuration and Calibration bits. Any externally timed write to the Configuration or Calibration Word will have no effect on the targeted word.

### FIGURE 4-9: BEGIN EXTERNALLY TIMED PROGRAMMING



#### 4.3.10 END EXTERNALLY TIMED PROGRAMMING

This command is required after a Begin Externally Timed Programming command is given. This command must be sent within the time window specified by TPEXT after the Begin Externally Timed Programming command is sent.

After sending the End Externally Timed Programming command, an additional delay (TDIS) is required before sending the next command. This delay is longer than the delay ordinarily required between other commands (see Figure 4-10).

#### FIGURE 4-10: END EXTERNALLY TIMED PROGRAMMING



#### 4.3.11 BULK ERASE PROGRAM MEMORY

The Bulk Erase Program Memory command performs two different functions dependent on the current state of the address.

Address 0000h-7FFFh:

Program Memory is erased Configuration Words are erased If  $\overline{CPD} = 0$ . Data Memory is erased

Address 8000h-8008h:

Program Memory is erased

Configuration Words are erased

User ID Locations are erased

If  $\overline{CPD} = 0$ , Data Memory is erased

A Bulk Erase Program Memory command should not be issued when the address is greater than 8008h.

#### FIGURE 4-11: BULK ERASE PROGRAM MEMORY



#### 4.3.12 BULK ERASE DATA MEMORY

To perform an erase of the data memory, after a Bulk Erase Data Memory command, wait a minimum of TERAB to complete Bulk Erase.

To erase data memory when data code-protect is active  $(\overline{CPD} = 0)$ , the Bulk Erase Program Memory command should be used.

After receiving the Bulk Erase Data Memory command, the erase will not complete until the time interval, TERAB, has expired.

**Note:** Data memory will not erase if codeprotected ( $\overline{CPD} = 0$ ).

#### FIGURE 4-12: BULK ERASE DATA MEMORY COMMAND



After receiving the Bulk Erase Program Memory command the erase will not complete until the time interval, TERAB, has expired.

Note: The code protection Configuration bit (CP) has no effect on the Bulk Erase Program Memory command.

#### 4.3.13 ROW ERASE PROGRAM MEMORY

The Row Erase Program Memory command will erase an individual row. A row of program memory consists of 32 consecutive 14-bit words. A row is addressed by the address PC<15:5>. If the program memory is codeprotected, the Row Erase Program Memory command will be ignored. When the address is 8000h-8008h the Row Erase Program Memory command will only erase the user ID locations regardless of the setting of the CP Configuration bit.

After receiving the Row Erase Program Memory command the erase will not complete until the time interval, TERAR, has expired.





### 5.0 PROGRAMMING ALGORITHMS

The devices have the capability of storing eight 14-bit words in its data latches. The data latches are internal and are only used for programming. The data latches allow the user to program up to eight program words with a single Begin Externally Timed Programming or Begin Internally Timed Programming command. The Load Program Data or the Load Configuration command is used to load a single data latch. The data latch will hold the data until the Begin Externally Timed Programming or Begin Internally Timed Programming or Begin Internally Timed Programming command is given.

The data latches are aligned with the 3 LSb of the address. The address at the time the Begin Externally Timed Programming or Begin Internally Timed Programming command is given will determine which location(s) in memory are written. Writes cannot cross a physical eight-word boundary. For example, attempting to write from address 0002h-0009h will result in data being written to 0008h-000Fh.

If more than 8 data latches are written without a Begin Externally Timed Programming or Begin Internally Timed Programming command the data in the data latches will be overwritten. The following figures show the recommended flowcharts for programming.

#### FIGURE 5-1: DEVICE PROGRAM/VERIFY FLOWCHART





#### FIGURE 5-3: ONE-WORD PROGRAM CYCLE





FIGURE 5-5:

#### CONFIGURATION MEMORY PROGRAM FLOWCHART





#### FIGURE 5-7: DATA MEMORY PROGRAM CYCLE





### 6.0 CODE PROTECTION

Code protection is controlled using the  $\overline{CP}$  bit in Configuration Word 1. When code protection is enabled, all program memory locations (0000h-7FFFh) read as all '0'. Further programming is disabled for the program memory (0000h-7FFFh). Program memory can still be programmed and read during program execution.

Data memory is protected with its own Code-Protect bit (CPD). When data code protection is enabled (CPD = 0), all data memory locations read as '0'. Further programming is disabled for the data memory. Data memory can still be programmed and read during program execution.

The user ID locations and Configuration Words can be programmed and read out regardless of the code protection settings.

### 6.1 Program Memory

Code protection is enabled by programming the  $\overline{CP}$  bit in Configuration Word 1 register to '0'.

The only way to disable code protection is to use the Bulk Erase Program Memory command.

### 6.2 Data Memory

Data memory protection is enabled by programming the  $\overline{CPD}$  bit in Configuration Word 1 register to '0'.

The only way to disable code protection is to use the Bulk Erase Program Memory command.

Note: To ensure system security, if CPD bit = 0, the Bulk Erase Program Memory command will also erase data memory.

### 7.0 HEX FILE USAGE

In the hex file there are two bytes per program word stored in the Intel<sup>®</sup> INHX32 hex format. Data is stored LSB first, MSB second. Because there are two bytes per word, the addresses in the hex file are 2x the address in program memory. (Example: The Configuration Word 1 is stored at 8007h on the PIC16F193X/LF193X/PIC16F194X/LF194X/

PIC16LF190X. In the hex file this will be referenced as 1000Eh-1000Fh).

### 7.1 Configuration Word

To allow portability of code, it is strongly recommended that the programmer is able to read the Configuration Words and user ID locations from the hex file. If the Configuration Words information was not present in the hex file, a simple warning message may be issued. Similarly, while saving a hex file, Configuration Words and user ID information should be included.

### 7.2 Device ID and Revision

If a device ID is present in the hex file at 1000Ch-1000Dh (8006h on the part), the programmer should verify the device ID (excluding the revision) against the value read from the part. On a mismatch condition the programmer should generate a warning message.

### 7.3 Data EEPROM

The programmer should be able to read data memory information from a hex file and write data memory contents to a hex file.

The physical address range of the 256 data memory is 0000h-00FFh. However, these addresses are logically mapped to address 1E000h-1E1FFh in the hex file. This provides a way of differentiating between the data and program memory locations in this range. The format for data memory storage is one data byte per address location, LSb aligned.

#### 7.4 Checksum Computation

The checksum is calculated by two different methods dependent on the setting of the  $\overline{CP}$  Configuration bit.

MASK VALUES									
Device	Config. Word 1 Mask	Config. Word 2 Mask							
PIC16F1933	3FFFh	3733h							
PIC16LF1933	3FFFh	3703h							
PIC16F1934	3FFFh	3733h							
PIC16LF1934	3FFFh	3703h							
PIC16F1936	3FFFh	3733h							
PIC16LF1936	3FFFh	3703h							
PIC16F1937	3FFFh	3733h							
PIC16LF1937	3FFFh	3703h							
PIC16F1938	3FFFh	3733h							
PIC16LF1938	3FFFh	3703h							
PIC16F1939	3FFFh	3733h							
PIC16LF1939	3FFFh	3703h							
PIC16F1946	3FFFh	3733h							
PIC16LF1946	3FFFh	3703h							
PIC16F1947	3FFFh	3713h							
PIC16LF1947	3FFFh	3703h							
PIC16LF1902	0EFBh	3E03h							
PIC16LF1903	0EFBh	3E03h							
PIC16LF1904	0EFBh	3E03h							
PIC16LF1906	0EFBh	3E03h							
PIC16LF1907	0EFBh	3E03h							

### TABLE 7-1:CONFIGURATION WORD<br/>MASK VALUES

#### 7.4.1 PROGRAM CODE PROTECTION DISABLED

With the program code protection disabled, the checksum is computed by reading the contents of the PIC16F193X/LF193X/PIC16F194X/LF194X/

PIC16LF190X program memory locations and adding up the program memory data starting at address 0000h, up to the maximum user addressable location (e.g., 1FFFH for the PIC16F1936). Any Carry bit exceeding 16 bits are ignored. Additionally, the relevant bits of the Configuration Words are added to the checksum. All unimplemented Configuration bits are masked to '0'.

Note:	Data	memory	does	not	effect	the
	check	sum.				

EXAMPLE 7-1:	CHECKSUM COMPUTED WITH PROGRAM CODE PROTECTION DISABLED
	PIC16F1936, BLANK DEVICE

PIC16F1936	Sum of Memory addresses 0000h-1FFFh		E000h
	Configuration Word 1		3FFFh
	Configuration Word 1	mask	3FFFh
	Configuration Word 2		3FFFh
	Configuration Word 2	2 mask <sup>(1)</sup>	3733h
	Checksum	= E000h + (3FFFh and	3FFFh) + (3FFFh and 3733h)
		= E000h + 3FFFh + 373	33h
		= 5732h	
Note de la	DICICE104V devices		not implemented in Configuration Word 2 and the

**Note 1:** In PIC16F194X devices, the VCAPEN<1> bit is not implemented in Configuration Word 2 and the Configuration Word 2 mask is 3713h.

#### EXAMPLE 7-2: CHECKSUM COMPUTED WITH PROGRAM CODE PROTECTION DISABLED PIC16LF1936, 00AAh AT FIRST AND LAST ADDRESS

2 and the
d

#### 7.4.2 PROGRAM CODE PROTECTION ENABLED

With the program code protection enabled the checksum is computed in the following manner. The Least Significant nibble of each user ID is used to create a 16-bit value. The masked value of user ID location 8000h is the Most Significant nibble. This sum of user IDs is summed with the Configuration Words (all unimplemented Configuration bits are masked to '0').

Note: Data memory does not effect the checksum.

### EXAMPLE 7-3: CHECKSUM COMPUTED WITH PROGRAM CODE PROTECTION ENABLED PIC16F1936, BLANK DEVICE

PIC16F1936	Configuration	Word 1	3F7Fh		
	Configuration	Word 1 mask	3FFFh		
	Configuration	Word 2	3FFFh		
	Configuration	Word 2 mask <sup>(1)</sup>	3733h		
	User ID (8000	h)	0005h		
	User ID (8001	h)	0007h		
	User ID (8002	h)	0003h		
	User ID (8003	h)	0002h		
	Sum of User II	•	) << 12 + (0007h and 000Fh) << 8 + ) << 4 + (0002h and 000Fh) 0030h + 0002h		
	Checksum	= (3F7Fh and 3FFFl = 3F7Fh + 3773h + = CDE4h	) + (3FFFh and 3733h) + Sum of User IDs 7732h		

Configuration Word 2 mask is 3713h.

#### EXAMPLE 7-4: CHECKSUM COMPUTED WITH PROGRAM CODE PROTECTION ENABLED PIC16LF1936, 00AAh AT FIRST AND LAST ADDRESS

		-	
PIC16LF1936	Configuration	Word 1	3F7Fh
	Configuration	Word 1 mask	3FFFh
	Configuration	Word 2	3FFFh
	Configuration	Word 2 mask <sup>(1)</sup>	3703h
	User ID (8000	h)	000Dh
	User ID (8001	h)	0008h
	User ID (8002h)		0005h
	User ID (8003	h)	0008h
	Sum of User I	Ds = (000Dh and 000Fh) << 12 + (0005h and 000Fh) << 4 + (0 = D000h + 0800h + 0050h + 00 = D858h	0008h and 000Fh)
	Checksum	= (3F7Fh and 3FFFh) + (3FFF = 3F7Fh + 3703h + D858h = 4EDAh	h and 3703h) + Sum of User IDs
		ices, the VCAPEN<1> bit is not 2 mask is 3713h.	implemented in Configuration Word 2 and the

### 8.0 ELECTRICAL SPECIFICATIONS

Refer to device specific data sheet for absolute maximum ratings.

#### TABLE 8-1: AC/DC CHARACTERISTICS TIMING REQUIREMENTS FOR PROGRAM/VERIFY MODE

AC/DC CHARACTERISTICS			Standard C Production	•			
Sym.	m. Characteristics			Тур.	Max.	Units	Conditions/Comments
		Supply Vo	ltages and o	urrents			
	VDD						
Vdd	Read/Write and Row Erase operations	PIC16F193X/ PIC16F194X	2.1	—	5.5	V	
		PIC16LF193X/ PIC16LF194X	2.1	—	3.6	V	
		PIC16LF190X	1.8	—	3.6	V	
	Bulk Erase operations	PIC16F193X/ PIC16F194X	2.7	—	5.5	V	
		PIC16LF193X/ PIC16LF194X	2.7	—	3.6	V	
		PIC16LF190X	2.6	—	3.6	V	
Iddi	Current on VDD, Idle		—	—	1.0	mA	
IDDP	Current on VDD, Programming		—	—	3.0	mA	
	Vpp				_		-
IPP	Current on MCLR/VPP		—	_	600	μA	
Vінн	High voltage on MCLR/VPP for Program/Verify mode entry	8.0	_	9.0	V		
TVHHR	MCLR rise time (VIL to VIHH) fo Program/Verify mode entry	r	_	_	1.0	μs	
	I/O pins						
Vih	(ICSPCLK, ICSPDAT, MCLR/V	0.8 VDD	_	_	V		
VIL	(ICSPCLK, ICSPDAT, MCLR/V	_		0.2 VDD	V		
Vон	ICSPDAT output high level	VDD-0.7 VDD-0.7 VDD-0.7	_	_	V	IOH = 3.5 mA, VDD = 5V IOH = 3 mA, VDD = 3.3V IOH = 2 mA, VDD = 1.8V	
Vol	ICSPDAT output low level	-	_	Vss+0.6 Vss+0.6 Vss+0.6	V	IOH = 8 mA, VDD = 5V IOH = 6 mA, VDD = 3.3V IOH = 3 mA, VDD = 1.8V	
		Programmin	ig mode entr	y and exit			
TENTS	Programing mode entry setup t ICSPDAT setup time before VD	ime: ICSPCLK,	100	_	_	ns	
Tenth	Programing mode entry hold tir ICSPDAT hold time after VDD o		250	_	_	μs	
		Serial	Program/Ve	rify			
TCKL	Clock Low Pulse Width		100		—	ns	
Тскн	Clock High Pulse Width	1	100	—	<u> </u>	ns	
TDS	Data in setup time before clock	$\downarrow$	100	—	—	ns	
Трн	Data in hold time after clock↓		100	—	-	ns	
Тсо	Clock↑ to data out valid (during Read Data command)		0	_	80	ns	
Tlzd	Clock↓ to data low-impedance Read Data command)		0		80	ns	
THZD	Clock↓ to data high-impedance Read Data command)		0		80	ns	
TDLY	Data input not driven to next clo required between command/da command)		1.0	_	_	μS	
Terab	Bulk Erase cycle time				5	ms	
TERAR	Row Erase cycle time		—	—	2.5	ms	

#### TABLE 8-1: AC/DC CHARACTERISTICS TIMING REQUIREMENTS FOR PROGRAM/VERIFY MODE

AC/DC CHARACTERISTICS		Standard Operating Conditions Production tested at 25°C				
Sym.	Characteristics	Min.	Тур.	Max.	Units	Conditions/Comments
TPINT	Internally timed programming operation time	_	_	2.5 5 5	ms	Program memory Configuration words Data EEPROM
TPEXT	Externally timed programming pulse	1.0	_	2.1	ms	Note 1
TDIS	Time delay from program to compare (HV discharge time)	300	_	_	μS	
TEXIT	Time delay when exiting Program/Verify mode	1	—	—	μs	

Note 1: Externally timed writes are not supported for Configuration and Calibration bits.

#### 8.1 AC Timing Diagrams



#### FIGURE 8-3:

PROGRAMMING MODE ENTRY – VPP FIRST





FIGURE 8-5:

#### PROGRAMMING MODE EXIT – VDD LAST

















### APPENDIX A: REVISION HISTORY

#### **Revision A (09/2009)**

Original release of this document.

#### **Revision B (08/2010)**

Revised Pin Diagrams; Added Notes to sections 4.3.1; Revised 4.3.9; Added Note 1 to Figure 5-3; Added Note 1 to Table 8-1; Other minor corrections; Added PIC16LF190X devices.

#### Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
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